



Cygnus Docket 0252.03
USSN 10/692,761
PATENT

DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

1. My residence, post office address and citizenship are as stated below next to my name. I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention titled:

ELECTROCHEMICAL SENSOR INK COMPOSITIONS, ELECTRODES, AND USES THEREOF

2. The specification of which (check one)

___ is attached hereto

or

X was filed on October 24, 2003 as Application Serial No. 10/692,761

and was amended on ___ (if applicable).

3. I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

4. I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56(a).

5. I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

Priority claimed?

Number	Country	Day/Month/Year Filed	Yes/No
NONE			

6. I hereby claim priority benefits under Title 35, United States Code § 119(e)(1) of any United States provisional application(s) for patent as indicated below and have also identified below any application for patent on this invention having a filing date before that of the application for patent on which priority is claimed:

<u>Application No.</u>	<u>Date of Filing</u> <u>(day/month/year)</u>	<u>Priority</u> <u>Claimed</u>
60/495,470	August 15, 2003	Yes <u>X</u> No <u> </u>

7. I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

<u>Application No.</u>	<u>Date of Filing</u> <u>(day/month/year)</u>	<u>Priority</u> <u>Claimed</u>	<u>Status</u>
NONE		Yes <u> </u> No <u> </u>	

8. I agree that the U.S. Serial Number (USSN) may be entered above by the assignee or its agents upon designation of the USSN by the United States Patent and Trademark Office.

9. I hereby declare that all statements made herein of my own knowledge are true, and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or by imprisonment, or both, under Section 1001 of Title 18 of the United States Code; and that such willful false statements may jeopardize the validity of the subject patent application or any patent issuing therefrom.

Signature: Huawen Li Date: 12/2/03

Full Name of Inventor: Huawen LI

Citizenship: US

Residence: Camarillo, California

Post Office Address: 10457 Summer View Circle, Camarillo, CA 93012

Signature: _____

Date: _____

Full Name of Inventor: Michael J. TIERNEY

Citizenship: US

Residence: San Jose, California

Post Office Address: 368 North Sixth Street, San Jose, CA 95112



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Prior Foreign Application(s)

Priority claimed?

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NONE			

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<u>Application No.</u>	<u>Date of Filing (day/month/year)</u>	<u>Priority Claimed</u>
60/495,470	August 15, 2003	Yes <u>X</u> No <u> </u>

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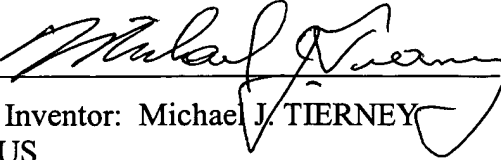
<u>Application No.</u>	<u>Date of Filing (day/month/year)</u>	<u>Priority Claimed</u>	<u>Status</u>
NONE		Yes <u> </u> No <u> </u>	

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Signature: _____ Date: _____

Full Name of Inventor: Huawei LI
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Signature: 

Date: 11/5/03

Full Name of Inventor: Michael J. TIERNEY

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